62

4.9...60

-30 ... +85

V

Ω

 $V_{\rm bbin(AZ)}$ 

 $V_{\rm bb(on)}$ 

 $R_{\text{ON}}$ 

 $T_{\rm a}$ 



## Smart High-Side Power Switch for Industrial Applications One channel: $1 \times 1 \Omega$

#### **Features**

- · Current controlled input
- Short circuit protection
- Current limitation
- · Overload protection
- Overvoltage protection (including load dump)
- Switching inductive loads
- · Clamp of negative voltage at output with inductive loads
- Thermal shutdown with restart
- ESD Protection
- Loss of GND and loss of V<sub>bb</sub> protection
- · Very low standby current
- Reverse battery protection
- Improved electromagnetic compatibility (EMC)

# PG-SOT223

#### **Application**

- All types of resistive, inductive and capacitive loads in industrial applications
- Current controlled power switch for 12V, 24V and 42V DC industrial applications

**Product Summary** 

Operating voltage

On-state resistance

Overvoltage protection

Operating Temperature

- Driver for electromagnetic relays
- Signal amplifier

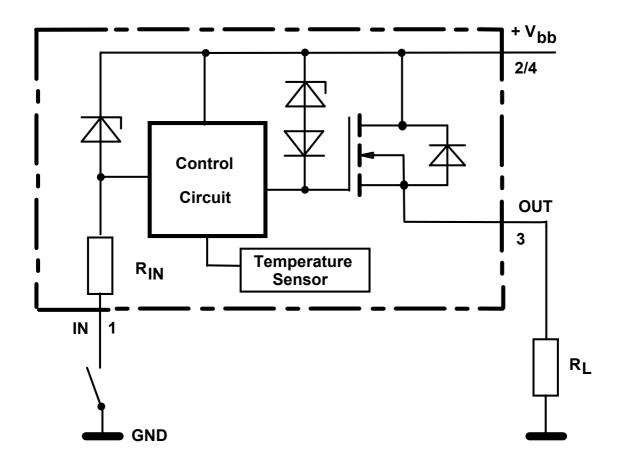
#### **General Description**

- N channel vertical power MOSFET with charge pump and current controlled input, monolithically integrated in Smart SIPMOS® technology.
- Providing embedded protection functions.

| Туре      | Ordering code | Package   |
|-----------|---------------|-----------|
| ITS 4140N | SP000240073   | PG-SOT223 |



#### **Block Diagram**



| Pin | Symbol | Function   |
|-----|--------|--|
| 1   | IN     | Input, activates the power switch in case of connection to GND |
| 2   | Vbb    | Positive power supply voltage                                  |
| 3   | OUT    | Output to the load   |
| 4   | Vbb    | Positive power supply voltage                                  |



#### **Maximum Ratings**

| Parameter at $T_j = 25$ °C unless otherwise specified  | Symbol   | Values                     | Unit |
|--|--|----------------------------|------|
| Supply voltage   | V <sub>bb</sub>                                | 60                         | V    |
| Load current (Short – circuit current, see page 5)   | <i>I</i> L                                     | self limited               | А    |
| Maximum current through the input pin (DC)   | I <sub>IN</sub>                                | ±15                        | mA   |
| Junction temperature Operating temperature range Storage temperature range   | T <sub>j</sub> T <sub>a</sub> T <sub>stg</sub> | +150<br>-30 +85<br>-40+105 | °C   |
| Power dissipation <sup>1)</sup> $T_a = 25 \text{ °C}$  | P <sub>tot</sub>                               | 1.7                        | W    |
| Inductive load switch-off energy dissipation <sup>2)</sup> Single pulse $T_j = 150^{\circ}\text{C}$ , $I_L = 0.15\text{A}$   | Eas  | 1                          | J    |
| Load dump protection <sup>3)</sup> $V_{\text{LoadDump}}^{4)} = V_{\text{A}} + V_{\text{S}}$<br>$R_{\text{L}}=2\Omega$ , $t_{\text{d}}=400\text{ms}$ , $V_{\text{IN}}=\text{low or high}$<br>$I_{\text{L}}=150\text{mA}$ , $V_{\text{bb}}=13.5\text{V}$<br>$V_{\text{bb}}=27\text{V}$ | V <sub>LoadDump</sub>                          | 93.5<br>127                | V    |
| Electrostatic discharge voltage (Human Body Model) According to ANSI EOS/ESD – S5.1 – 1993 ESD STM5.1 – 1998 Input pin all other pins  | V <sub>ESD</sub>                               | ±1<br>±5                   | kV   |

 $<sup>^{1}</sup>$  Device on 50mm\*50mm\*1.5mm epoxy PCB FR4 with 6 cm2 (one layer, 70 $\mu$ m thick) copper area for  $V_{bb}$  connection. PCB is vertical without blown air.

<sup>&</sup>lt;sup>2</sup> Not subject to production test, specified by design

<sup>&</sup>lt;sup>3</sup> More details see EMC-Characteristics on page 7

 $<sup>^4</sup>$   $V_{\rm LoadDump}$  is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839.



#### **Electrical Characteristics**

| Parameter   | Symbol                | Values |      | Unit               |      |
|---|-----------------------|--------|------|--------------------|------|
| at $T_j$ = -40150 °C, $V_{bb}$ = 942 V unless otherwise specified                           |                       | min.   | typ. | max.               |      |
| Thermal Characteristics   | _                     | _      |      |                    |      |
| Thermal resistance @ min. footprint   | $R_{th(JA)}$          | -      | 86   | 125                | K/W  |
| Thermal resistance @ 6 cm <sup>2</sup> cooling area <sup>1)</sup>                           | $R_{th(JA)}$          | -      | 60   | 72                 |      |
| Thermal resistance, junction - soldering point  | R <sub>thJS</sub>     | _      | -    | 17                 | K/W  |
| Load Switching Capabilities and Characteristics   |                       |        |      |                    |      |
| On-state resistance   | R <sub>ON</sub>       |        |      |                    | Ω    |
| Pin1 connected to GND   |                       |        |      |                    |      |
| $T_{\rm j}$ = 25 °C, $I_{\rm L}$ = 150 mA, $V_{\rm bb}$ = 952 V                             |                       | -      | 1    | 1.5                |      |
| <i>T</i> <sub>j</sub> = 150 °C  |                       | -      | 1.5  | 3                  |      |
| $T_{\rm j}$ = 25 °C, $I_{\rm L}$ = 50 mA, $V_{\rm bb}$ = 6 V                                |                       | -      | 2    | 5                  |      |
| Nominal load current <sup>2)</sup>  | / <sub>L(nom)</sub>   | 0.2    | -    | -                  | Α    |
| Device on PCB <sup>1)</sup>   |                       |        |      |                    |      |
| $T_a = 85  ^{\circ}\text{C}$ , $T_j \leq 150  ^{\circ}\text{C}$                             |                       |        |      |                    |      |
| Turn-on time <sup>3)</sup> $V_{IN} = V_{bb}$ to 0V to 90% $V_{OUT}$                         | $t_{on}$              |        |      |                    | μs   |
| $R_{L}$ = 270 $\Omega$  |                       | -      | -    | 125 <sup>4</sup> ) |      |
| $R_{\rm L}$ = 270 $\Omega$ , $V_{\rm bb}$ = 13.5 V, $T_{\rm j}$ = 25 °C                     |                       | -      | 45   | 100                |      |
| Turn-off time <sup>3)</sup> $V_{IN} = 0V \text{ to } V_{bb}$ to 10% $V_{OUT}$               | $t_{\rm off}$         |        |      |                    |      |
| $R_{L}$ = 270 $\Omega$  |                       | -      | -    | 1754)              |      |
| $R_{\rm L} = 270 \ \Omega, \ V_{\rm bb} = 13.5 \ \rm V, \ T_{\rm j} = 25 \ ^{\circ}\rm C$   |                       | -      | 40   | 140                |      |
| Slew rate on <sup>3)</sup> $V_{\text{IN}} = V_{\text{bb}}$ to 0V 10 to 30% $V_{\text{OUT}}$ | dV/dt <sub>on</sub>   |        |      |                    | V/µs |
| $R_{L}$ = 270 $\Omega$  |                       | -      | -    | 6 <sup>4)</sup>    |      |
| $R_{\rm L}$ = 270 $\Omega$ , $T_{\rm j}$ = 25 °C, $V_{\rm bb}$ = 13.5 V                     |                       | -      | 1.3  | 4                  |      |
| Slew rate off <sup>3)</sup> $V_{IN}$ = 0V to $V_{bb}$ 70 to 40% $V_{OUT}$                   | -dV/dt <sub>off</sub> |        |      |                    |      |
| $R_{L}$ = 270 $\Omega$  |                       | -      | -    | 84)                |      |
| $R_{\rm L}$ = 270 $\Omega$ , $T_{\rm j}$ = 25 °C, $V_{\rm bb}$ = 13.5 V                     |                       | -      | 1.7  | 4                  |      |

 $<sup>^{1}</sup>$ Device on 50mm\*50mm\*1.5mm epoxy PCB FR4 with 6 cm2 (one layer, 70 $\mu$ m thick) copper area for  $V_{bb}$  connection. PCB is vertical without blown air.

<sup>&</sup>lt;sup>2</sup>Nominal load current is limited by the current limitation ( see page 5 )

 $<sup>^{3}\</sup>mbox{Timing}$  values only with high input slewrates, otherwise slower.

<sup>&</sup>lt;sup>4</sup>not subject to production test, specified by design





#### **Electrical Characteristics**

| Parameter   | Symbol                | Values |      |      | Unit |
|---|-----------------------|--------|------|------|------|
| at $T_{\rm j}$ = -40150 °C, $V_{\rm bb}$ = 942 V unless otherwise specified |                       | min.   | typ. | max. |      |
| Operating Parameters  |                       |        |      | ,    |      |
| Operating voltage   | $V_{\rm bb(on)}$      | 4.9    | ı    | 60   | V    |
| Standby current   | / <sub>bb(off)</sub>  | -      | 2    | 10   | μA   |
| Pin1 = open   |                       |        |      |      |      |
| Protection Functions <sup>1)</sup>  |                       |        |      |      |      |
| Initial peak short circuit current limit                                    | / <sub>L(SCp)</sub>   |        |      |      | Α    |
| (see page 14)   |                       |        |      |      |      |
| $T_{\rm j}$ = -40 °C, $V_{\rm bb}$ = 13.5 V, $t_{ m m}$ = 100 $\mu  m s$    |                       | -      | -    | 1.2  |      |
| T <sub>j</sub> = 25 °C  |                       | -      | 0.9  | -    |      |
| <i>T</i> <sub>j</sub> = 150 °C  |                       | 0.2    | -    | -    |      |
| Repetitive short circuit current limit                                      | / <sub>L(SCr)</sub>   | -      | 0.7  | -    |      |
| $T_j = T_{jt}$  |                       |        |      |      |      |
| Output clamp (inductive load switch off)                                    | V <sub>ON(CL)</sub>   | 60     | -    | -    | V    |
| at $V_{\text{OUT}} = V_{\text{bb}} - V_{\text{ON(CL)}}$                     | , ,                   |        |      |      |      |
| $I_{\rm bb} = 4 \text{ mA}$   |                       |        |      |      |      |
| Overvoltage protection  | V <sub>bbin(AZ)</sub> | 62     | 68   | -    |      |
| $I_{\rm bb} = 1 \text{ mA}$   |                       |        |      |      |      |
| Thermal overload trip temperature   | $T_{jt}$              | 150    | -    |      | °C   |
| Thermal hysteresis  | $\Delta T_{\rm jt}$   | -      | 10   | _    | K    |

<sup>&</sup>lt;sup>1</sup>Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.



#### **Electrical Characteristics**

| Parameter   | Symbol               | Values |      | Unit |    |
|---|----------------------|--------|------|------|----|
| at $T_i$ = -40150 °C, $V_{bb}$ = 942 V unless otherwise specified |                      | min.   | typ. | max. |    |
| Input   | •                    |        |      | •    |    |
| Off state input current   | / <sub>IN(off)</sub> |        |      |      | mΑ |
| $V_{\text{OUT}} \leq 0.1 \text{ V}$                               |                      |        |      |      |    |
| $T_{\rm j}$ = 25 °C, $R_{\rm L}$ = 270 $\Omega$                   |                      | -      | -    | 0.05 |    |
| $T_{j} = 150  ^{\circ}\text{C}$                                   |                      | _      | -    | 0.04 |    |
| On state input current ( Pin1 grounded )1)                        | / <sub>IN(on)</sub>  | -      | 0.3  | 1    |    |
| Input resistance  | $R_{I}$              | 0.5    | 1    | 2.5  | kΩ |
|   |                      |        |      | •    |    |
| Reverse Battery   |                      |        |      |      |    |
| Continuous reverse drain current                                  | Is                   | _      | -    | 0.2  | Α  |
| T <sub>C</sub> = 25 °C  |                      |        |      |      |    |

 $-V_{ON}$ 

600

mV

Drain-source diode voltage ( $V_{OUT} > V_{bb}$ )

 $I_{\text{F}} = 0.2 \text{ A}, I_{\text{IN}} \le 0.05 \text{ mA}$ 

<sup>&</sup>lt;sup>1</sup>Driver circuit must be able to drive currents > 1mA.



#### **EMC-Characteristics**

All EMC-Characteristics are based on limited number of sampels and no part of production test.

#### **Test Conditions:**

If not other specified the test circuitry is the minimal functional configuration without any external components for protection or filtering.

Supply voltage:  $V_{bb} = 13.5 \text{V}$  Temperature:  $T_a = 23 \pm 5 ^{\circ} \text{C}$ ;

Load:  $R_{\parallel} = 220\Omega$ 

Operation mode: PWM Frequency: 100Hz / Duty Cycle: 50%

DC On/Off

DUT-Specific.: -

#### Fast electrical transients

Acc. ISO 7637

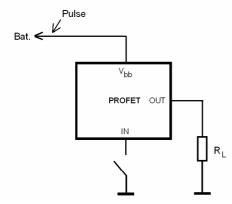
| Test Pulse | Test Level | Test Results |          | Pulse Cycle Time and            |
|------------|------------|--------------|----------|---------------------------------|
|            |            | On           | Off      | Generator Impedance             |
| 1          | -200 V     | С            | С        | 500ms ; 10 $\Omega$             |
| 2          | +200 V     | С            | С        | $500 \mathrm{ms}$ ; $10 \Omega$ |
| 3a         | -200 V     | С            | С        | 100ms ; 50 $\Omega$             |
| 3b         | + 200 V    | С            | С        | 100ms ; 50 $\Omega$             |
| 41)        | -7 V       | C            | C        | 0,01Ω                           |
| 5          | 175 V      | E (150V)     | E (150V) | 400ms ; $2\Omega$               |

The test pulses are applied at  $V_{\rm bb}$ 

#### **Definition of functional status**

| Class | Content  |  |
|-------|--|--|
| С     | All functions of the device are performed as designed after exposure to disturbance. |  |
| E     | One or more function of a device does not perform as designed after exposure         |  |
|       | and can not be returned to proper operation without repairing or replacing the       |  |
|       | device. The value after the character shows the limit.                               |  |

#### **Test circuit:**



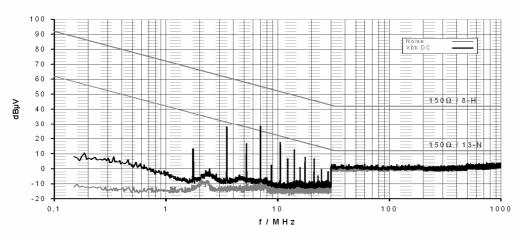
<sup>&</sup>lt;sup>1</sup>Supply voltage  $V_{bb}$  = 12 V instead of 13.5 V.



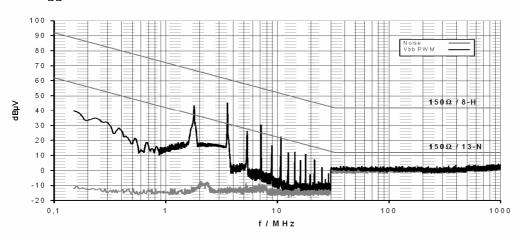
#### **Conducted Emission**

Acc. IEC 61967-4 ( $1\Omega$  /  $150\Omega$  method)

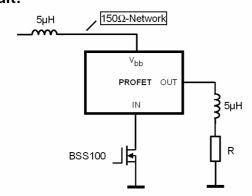
Typ.  $V_{bb}$ -Pin Emission at DC-On with 150  $\Omega$ -matching network



Typ.  $V_{bb}$ -Pin Emission at PWM-Mode with 150  $\Omega$ -matching network



#### **Test circuit:**



For defined decoupling and high reproducibility a defined choke (5 $\mu$ H at 1 MHz) is inserted between supply and  $V_{bb}$ -pin.



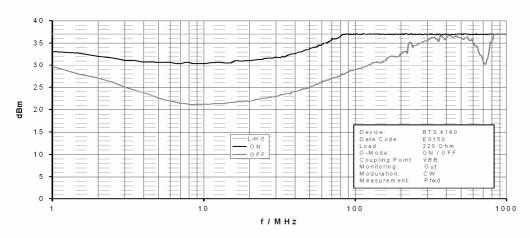
#### **Conducted Susceptibility**

Acc. 47A/658/CD IEC 62132-4 (Direct Power Injection)

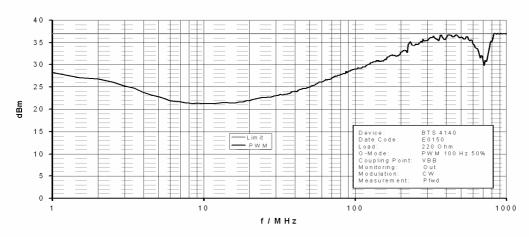
**Direct Power Injection:** Forward Power CW

Failure criteria: Amplitude and frequency deviation max. 10% at Out

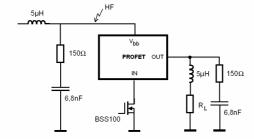
#### Typ. Vbb-Pin Susceptibility at DC-On/Off



#### Typ. V<sub>bb</sub>-Pin Susceptibility at PWM-Mode



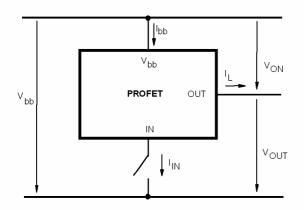
#### **Test circuit:**



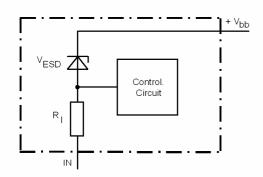
For defined decoupling and high reproducibility the same choke and the same  $150\Omega$  -matching network as for the emission measurement is used.



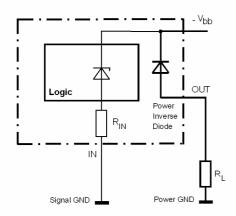
#### **Terms**



#### Input circuit (ESD protection)

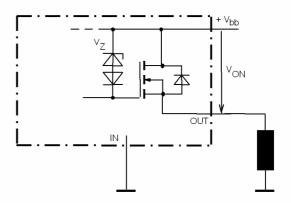


#### **Reverse battery protection**



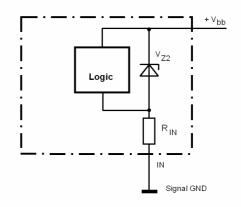
 $R_i=1k\Omega$  typ., Temperature protection is not active during inverse current.

#### Inductive and overvoltage output clamp



 $V_{\mathrm{ON}}$  clamped to 60 V min.

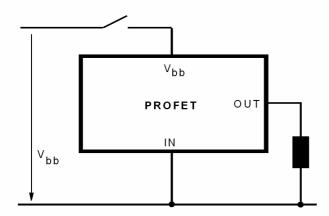
#### Overvoltage protection of logic part



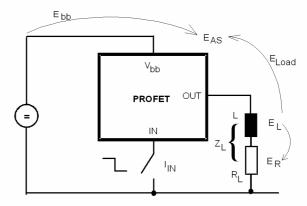
 $V_{\rm bb,AZ} = V_{Z2} + I_{\rm bb} * R_{\rm IN} = 62 \text{V min.}$ 



## V<sub>bb</sub> disconnect with charged inductive load



### Inductive Load switch-off energy dissipation



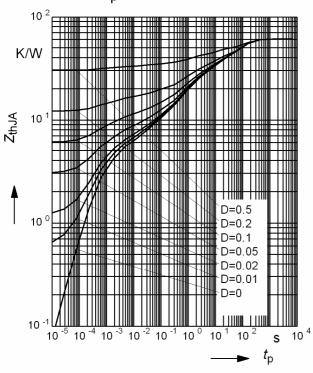
Energy stored in load inductance:  $E_L = \frac{1}{2} * L * I_L^2$  While demagnetizing load inductance, the energy dissipated in PROFET is  $E_{AS} = E_{bb} + E_L - E_R = V_{ON(CL)} * i_L(t) dt$ , with an approximate solution for  $R_L > 0\Omega$ :

$$E_{AS} = \frac{L}{R_L} \cdot \left(V_{bb} + \left|V_{OUT(CL)}\right|\right) \cdot \left[\frac{-\left|V_{OUT(CL)}\right|}{R_L} \cdot \ln\left(1 + \frac{R_L \cdot I_L}{\left|V_{OUT(CL)}\right|}\right) + I_L\right]$$



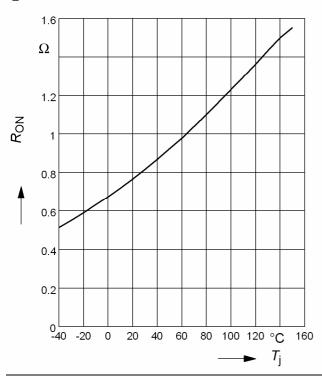
## Typ. transient thermal impedance $Z_{\text{thJA}} = f(t_p) @ 6 \text{cm}^2 \text{ heatsink area}$

Parameter:  $D=t_p/T$ 



#### Typ. on-state resistance

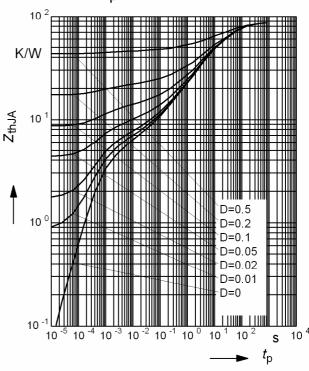
 $R_{ON} = f(T_j)$ ;  $V_{bb} = 9V$ ; Pin1 grounded;  $I_I = 150 \text{mA}$ 



#### Typ. transient thermal impedance

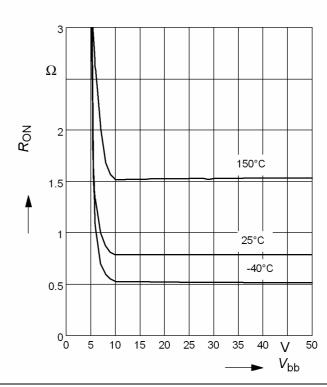
#### $Z_{\text{thJA}}$ =f( $t_{\text{p}}$ ) @ min. footprint

Parameter:  $D=t_p/T$ 



#### Typ. on-state resistance

 $R_{ON} = f(V_{bb})$ ;  $I_L = 150 \text{mA}$ ; Pin1 grounded

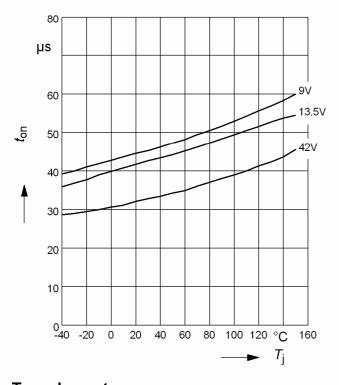




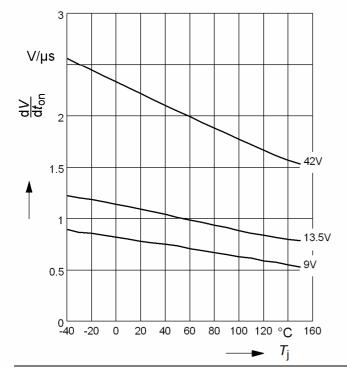


Typ. turn on time

$$t_{on} = f(T_j)$$
;  $R_L = 270\Omega$ 

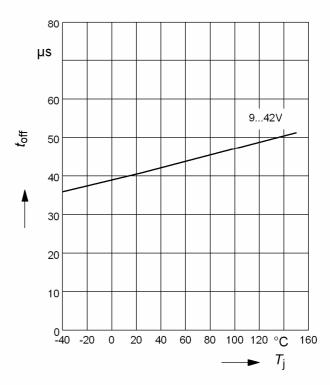


Typ. slew rate on  $dV/dt_{on} = f(T_j)$ ;  $R_L = 270 \Omega$ 



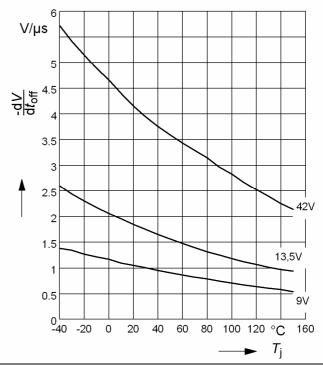
Typ. turn off time

$$t_{\text{off}} = f(T_{j}); R_{L} = 270\Omega$$



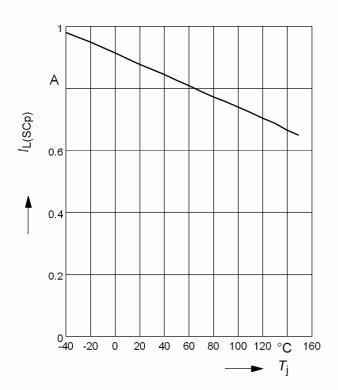
Typ. slew rate off

$$dV/dt_{off} = f(T_j); R_L = 270 \Omega$$

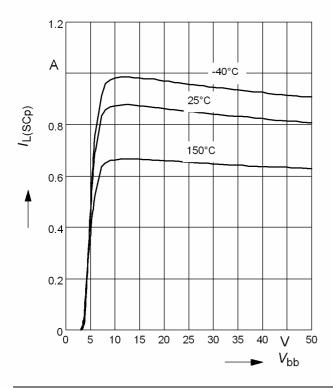




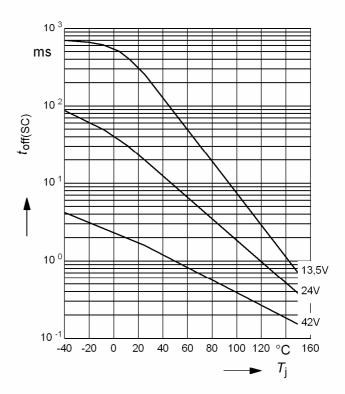
Typ. initial peak short circuit current limit  $I_{L(SCp)} = f(T_j)$ ;  $V_{bb} = 13.5 \text{ V}$ ;  $t_m = 100 \text{ }\mu\text{s}$ 



Typ. initial peak short circuit current limit  $I_{L(SCp)} = f(V_{bb}); t_m = 100 \ \mu s$ 

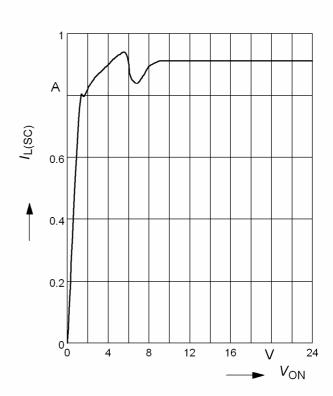


Typ. initial short circuit shutdown time  $t_{\text{off(SC)}} = f(T_{j,\text{start}})$ 



Typ. current limitation characteristic:

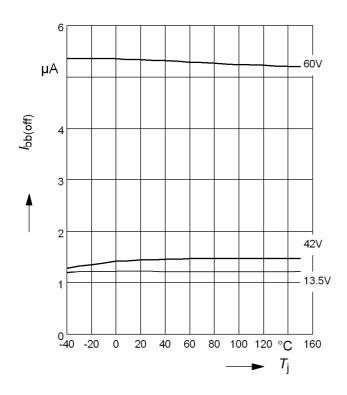
$$I_{L(SC)} = f(V_{ON}), V_{bb} = 13,5V$$





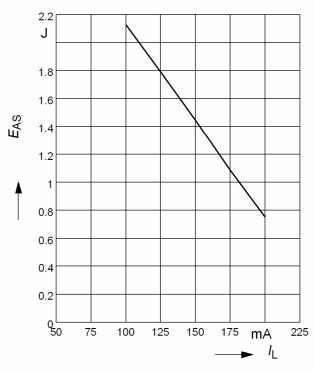
#### Typ. standby current

 $I_{bb(off)} = f(T_j)$ ; Pin1 open



## Maximum allowable inductive switch-off energy, single pulse

$$E_{AS} = f(I_L); T_{jstart} = 150$$
°C





#### **Timing diagrams**

Figure 1a: Vbb turn on:

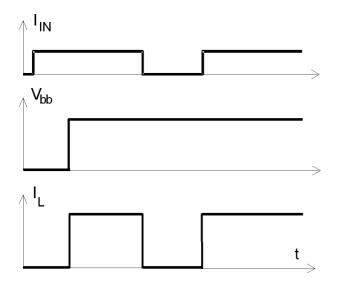
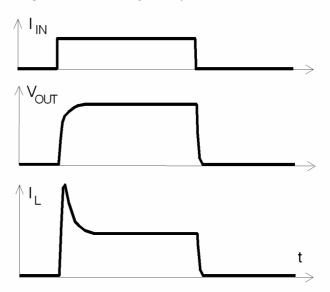


Figure 2b: Switching a lamp



**Figure 2a:** Switching a resistive load, turn-on/off time and slew rate definition

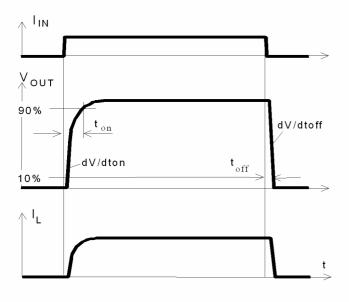
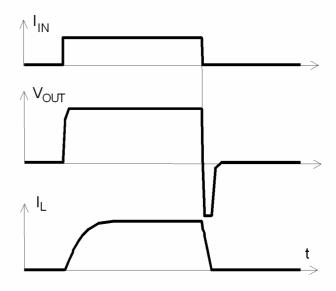
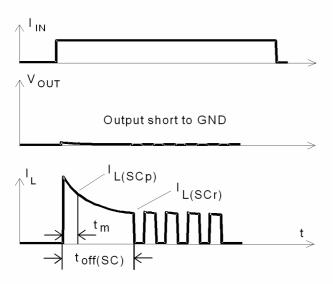


Figure 2c: Switching an inductive load



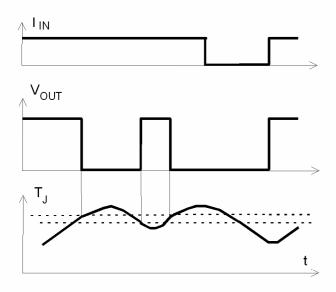


**Figure 3a:** Turn on into short circuit, shut down by overtemperature, restart by cooling

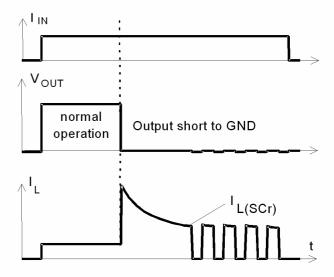


Heating up of the chip may require several milliseconds, depending on external conditions.

**Figure 4**: Overtemperature: Reset if T<sub>i</sub> < T<sub>it</sub>



**Figure 3b:** Short circuit in on-state shut down by overtemperature, restart by cooling

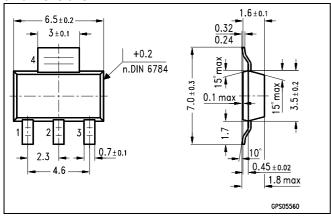




#### Package and ordering code:

| Туре      | Ordering code | Package   |
|-----------|---------------|-----------|
| ITS 4140N | SP000240073   | PG-SOT223 |

#### all dimensions in mm.



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